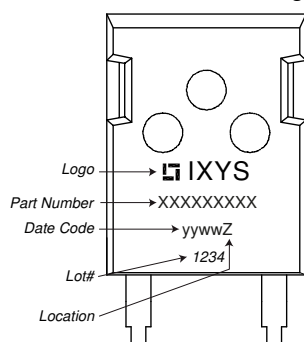


Fast Diode				Ratings				
Symbol	Definition	Conditions		min.	typ.	max.	Unit	
V _{RSM}	max. non-repetitive reverse blocking voltage	T _{VJ} = 25°C				1800	V	
V _{RRM}	max. repetitive reverse blocking voltage	T _{VJ} = 25°C				1800	V	
I _R	reverse current, drain current	V _R = 1800 V	T _{VJ} = 25°C			100	μA	
		V _R = 1800 V	T _{VJ} = 125°C			1	mA	
V _F	forward voltage drop	I _F = 40 A	T _{VJ} = 25°C			2.06	V	
		I _F = 80 A				2.56	V	
		I _F = 40 A	T _{VJ} = 125°C			2.08	V	
		I _F = 80 A				2.79	V	
I _{FAV}	average forward current	T _C = 100°C rectangular d = 0.5	T _{VJ} = 150°C			40	A	
V _{F0}	threshold voltage	} for power loss calculation only		T _{VJ} = 150°C		1.38	V	
r _F	slope resistance					17.5	mΩ	
R _{thJC}	thermal resistance junction to case					0.45	K/W	
R _{thCH}	thermal resistance case to heatsink				0.3		K/W	
P _{tot}	total power dissipation	T _C = 25°C				280	W	
I _{FSM}	max. forward surge current	t = 10 ms; (50 Hz), sine; V _R = 0 V		T _{VJ} = 45°C		400	A	
C _J	junction capacitance	V _R = 900 V f = 1 MHz		T _{VJ} = 25°C	19		pF	
I _{RM}	max. reverse recovery current	} I _F = 60 A; V _R = 900 V -di _F / dt = 750 A/μs		T _{VJ} = 25 °C	50		A	
				T _{VJ} = 125 °C	60		A	
t _{rr}	reverse recovery time			T _{VJ} = 25 °C	300		ns	
				T _{VJ} = 125 °C	550		ns	

Package TO-247			Ratings			
Symbol	Definition	Conditions	min.	typ.	max.	Unit
I_{RMS}	RMS current	per terminal			70	A
T_{VJ}	virtual junction temperature		-55		150	°C
T_{op}	operation temperature		-55		125	°C
T_{stg}	storage temperature		-55		150	°C
Weight				6		g
M_D	mounting torque		0.8		1.2	Nm
F_C	mounting force with clip		20		120	N

Product Marking

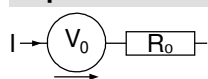


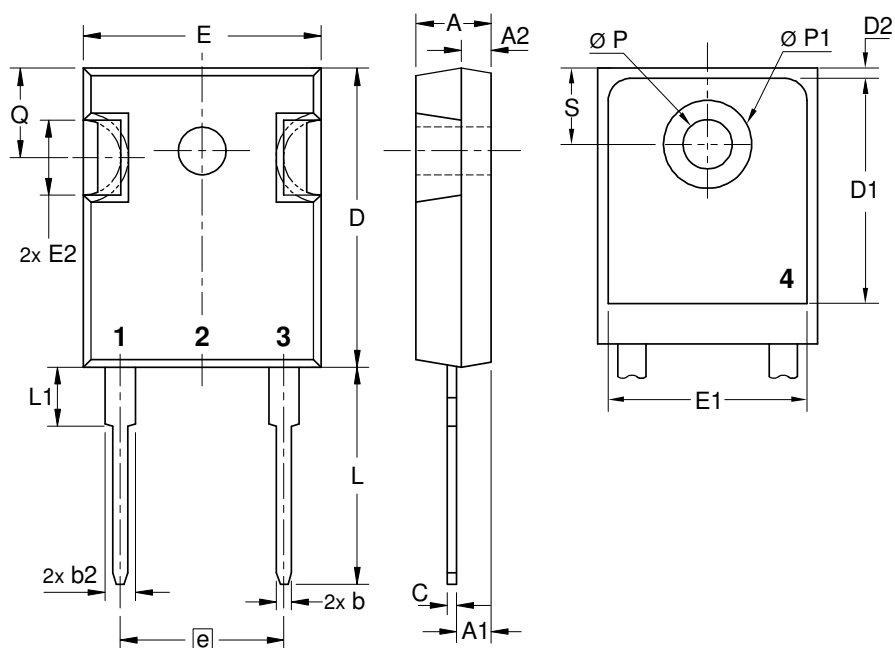
Ordering	Ordering Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	DH40-18A	DH40-18A	Tube	30	499765

Equivalent Circuits for Simulation

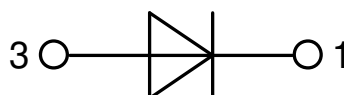
* on die level

$T_{VJ} = 150^{\circ}\text{C}$

			Fast Diode	
$V_{0\max}$	threshold voltage	1.38		V
$R_{0\max}$	slope resistance *	14.5		mΩ

Outlines TO-247


Sym.	Inches		Millimeter	
	min.	max.	min.	max.
A	0.185	0.209	4.70	5.30
A1	0.087	0.102	2.21	2.59
A2	0.059	0.098	1.50	2.49
D	0.819	0.845	20.79	21.45
E	0.610	0.640	15.48	16.24
E2	0.170	0.216	4.31	5.48
e	0.430	BSC	10.92	BSC
L	0.780	0.800	19.80	20.30
L1	-	0.177	-	4.49
Ø P	0.140	0.144	3.55	3.65
Q	0.212	0.244	5.38	6.19
S	0.242	BSC	6.14	BSC
b	0.039	0.055	0.99	1.40
b2	0.065	0.094	1.65	2.39
b4	0.102	0.135	2.59	3.43
c	0.015	0.035	0.38	0.89
D1	0.515	-	13.07	-
D2	0.020	0.053	0.51	1.35
E1	0.530	-	13.45	-
Ø P1	-	0.29	-	7.39



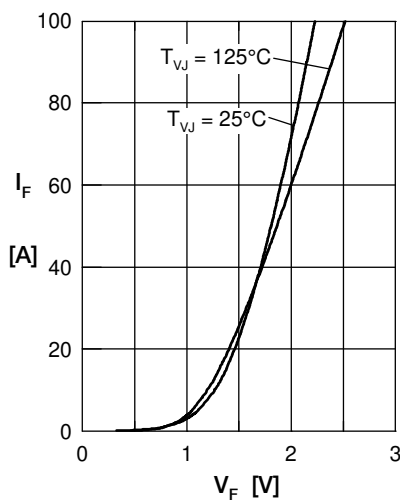
Fast Diode


Fig. 1 Forward current I_F versus V_F

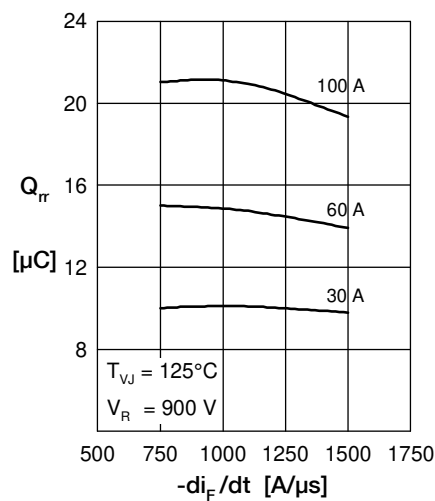


Fig. 2 Typ. reverse recovery charge Q_{rr} versus $-di_F/dt$

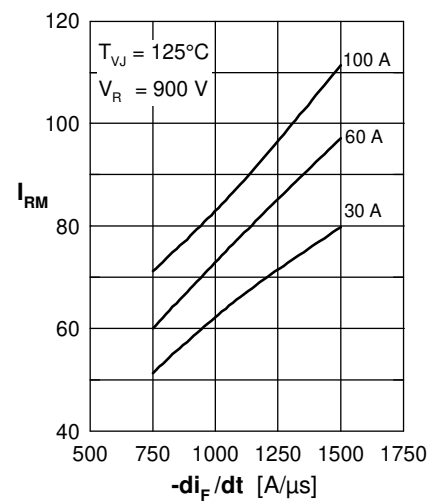


Fig. 3 Typ. peak reverse current I_{RM} versus $-di_F/dt$

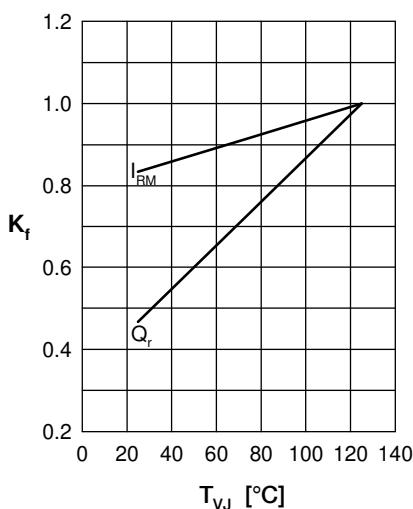


Fig. 4 Dyn. parameters Q_r , I_{RM} versus T_{VJ}

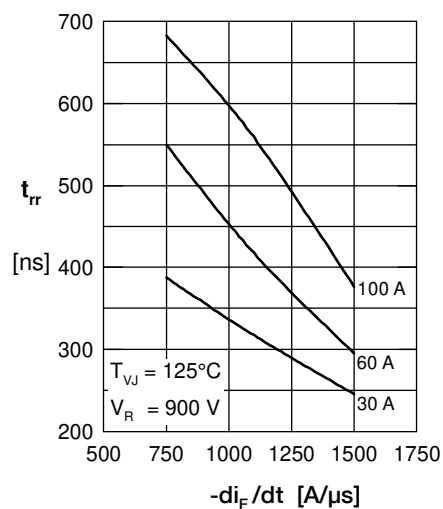


Fig. 5 Typ. recovery time t_{rr} versus $-di_F/dt$

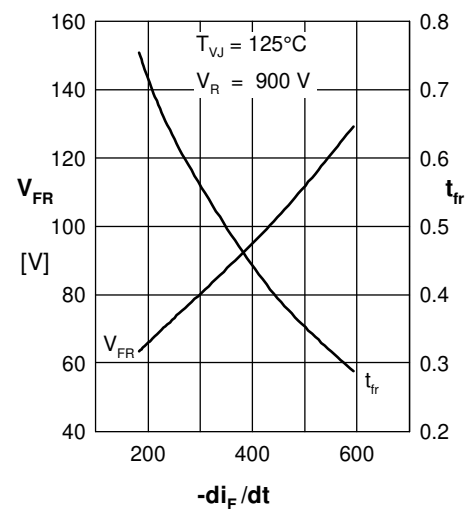


Fig. 6 Typ. peak forward voltage V_{FR} and t_{fr} versus di_F/dt

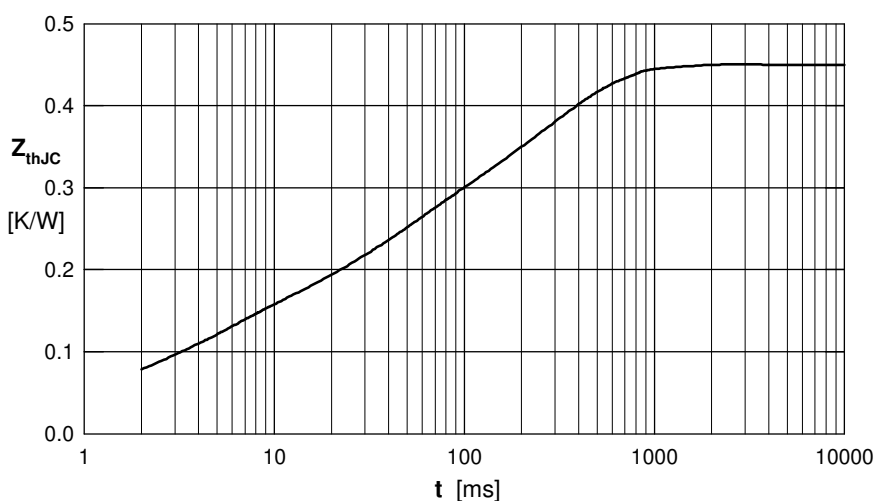


Fig. 7 Transient thermal impedance junction to case

Constants for Z_{thJC} calculation:

i	R_{th} (K/W)	t_i (s)
1	0.033	0.0006
2	0.095	0.0039
3	1.114	0.0330
4	0.208	0.2720